| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|----------|--------|--|---|---------------------|---------|------------------|
| L1 | 3 | (("6117770") or ("6395152") or ("20040067640")).PN. | US-PGPUB; USPAT | OR | OFF | 2006/05/01 02:57 |
| L2 | 407609 | ("438"/\$.ccls. or "257"/\$.ccls.) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/01 03:01 |
| L3 | 17391 | ((438/622) or (438/625) or (438/626) or (438/627) or (438/628) or (438/629) or (438/631) or (438/633) or (438/634) or (438/637) or (438/638) or (438/643) or (438/645) or (438/648) or (438/652) or (438/653) or (438/654) or (438/652) or (438/659) or (438/672) or (438/685) or (438/687) or (438/691) or (438/692) or (438/695) or (438/697) or (438/700)). CCLS. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/05/01 03:02 |
| L4 | 17391 | ((438/622) or (438/625) or (438/626) or (438/627) or (438/628) or (438/629) or (438/631) or (438/633) or (438/634) or (438/637) or (438/638) or (438/643) or (438/645) or (438/648) or (438/652) or (438/653) or (438/654) or (438/652) or (438/669) or (438/672) or (438/685) or (438/687) or (438/691) or (438/697) or (438/700)). CCLS. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/05/01 03:02 |
| L5 | 146 | L4 and (electropolish\$3 or (electrolytic adj etch\$3) or (electro adj planariz\$5)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/01 03:02 |
| L6 | 38 | 5 and ((wafer or substrate) same (immers\$3 or submers\$3)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/01 03:03 |
| L7 | 27 | 5 and ((wafer or substrate) same (immers\$3 or submers\$3) same electrolyt\$2) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/01 03:04 |

| | · | | _ | , | | |
|----|-------|---|---|--------------|-----|------------------|
| S1 | 13999 | ((438/622) or (438/625) or (438/626) or (438/627) or (438/628) or (438/629) or (438/631) or (438/633) or (438/634) or (438/637) or (438/638) or (438/643) or (438/645) or (438/645) or (438/645) or (438/652) or (438/653) or (438/654) or (438/656) or (438/659) or (438/672) or (438/685) or (438/697) or (438/691) or (438/697) or (438/700)). CCLS. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR . | OFF | 2006/05/01 03:02 |
| S2 | 88 | S1 and (electropolish\$3 or (electrolytic adj etch\$3) or (electro adj planariz\$5)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/01 03:02 |
| S3 | 57 | S2 and (barrier near2 layer) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/02 14:33 |
| S4 | 8 | S3 and ((electropolish\$3 or (electrolytic adj etch\$3) or (electro adj planariz\$5)) near5 (barrier adj layer)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/02 14:55 |
| S5 | 2 | S4 and adhesion | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/02 15:13 |
| S6 | 1 | ("6176992").PN. | USPAT; USOCR | OR | OFF | 2004/09/02 15:13 |
| S7 | 7312 | ("0000650").PN. or ((438/678) or (438/679) or (438/438/627) or (438/653) or (438/656) or (438/643) or (438/648) or (438/685) or (438/686) or (438/633) or (438/637) or (438/638)).CCLS. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2003/12/04 01:57 |
| S8 | 79 | (("0000650").PN. or ((438/678) or (438/679) or (438/438/627) or (438/653) or (438/656) or (438/643) or (438/648) or (438/685) or (438/686) or (438/633) or (438/637) or (438/637) or (438/638)).CCLS.) and barrier and electrolyt\$5 and potential | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2003/12/04 02:04 |

| S9 | 73 | ((("0000650").PN. or ((438/678) or (438/679) or (438/438/627) or (438/653) or (438/656) or (438/643) or (438/648) or (438/685) or (438/686) or (438/633) or (438/687) or (438/637) or (438/638)).CCLS.) and barrier and electrolyt\$5 and potential) and (copper or cu) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2003/12/04 02:04 |
|-----|------|--|---|----|----|------------------|
| S10 | 4 | (((("0000650").PN. or ((438/678) or (438/679) or (438/438/627) or (438/653) or (438/656) or (438/643) or (438/648) or (438/685) or (438/686) or (438/633) or (438/687) or (438/637) or (438/638)).CCLS.) and barrier and electrolyt\$5 and potential) and (copper or cu)) and (electrolyt\$5 same (koh or (potassium adj hydroxide) or naoh or (sodium adj hydroxide) or (ammonium adj hydroxide) or (nh adj2 oh) or (tetra adj2 methyl adj ammonium and hydroxide) or tmah)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2003/12/04 02:20 |
| S11 | 4 | ((((("0000650").PN. or ((438/678) or (438/679) or (438/438/627) or (438/653) or (438/656) or (438/643) or (438/648) or (438/685) or (438/686) or (438/633) or (438/687) or (438/637) or (438/638)).CCLS.) and barrier and electrolyt\$5 and potential) and (copper or cu)) and (electrolyt\$5 same (koh or (potassium adj hydroxide) or naoh or (sodium adj hydroxide) or (ammonium adj hydroxide) or (nh adj2 oh) or (tetra adj2 methyl adj ammonium and hydroxide) or tmah))) and ph | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2003/12/04 02:16 |
| S12 | 8776 | damascene | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2003/12/04 02:17 |
| S13 | 5486 | damascene and copper | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2003/12/04 02:17 |
| S14 | 1668 | (damascene and copper) and barrier and seed | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2003/12/04 02:17 |

| S15 | 877 | ((damascene and copper) and barrier and seed) and adhesion | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2003/12/04 02:18 |
|-----|-----|--|---|-----------------|----|------------------|
| S16 | 687 | (((damascene and copper) and barrier and seed) and adhesion) and ((expos\$4 same barrier) or ((etch\$4 or remove) same seed)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR [.] | ON | 2003/12/04 02:19 |
| S17 | 168 | ((((damascene and copper) and barrier and seed) and adhesion) and ((expos\$4 same barrier) or ((etch\$4 or remove) same seed))) and (electrolyte or electrolyt\$3) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2003/12/04 02:20 |
| S18 | 71 | (((((damascene and copper) and barrier and seed) and adhesion) and ((expos\$4 same barrier) or ((etch\$4 or remove) same seed))) and (electrolyte or electrolyt\$3)) and potential | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2003/12/04 02:20 |
| S19 | | (((((((damascene and copper) and barrier and seed) and adhesion) and ((expos\$4 same barrier) or ((etch\$4 or remove) same seed))) and (electrolyte or electrolyt\$3)) and potential) and (electrolyt\$5 same (koh or (potassium adj hydroxide) or naoh or (sodium adj hydroxide) or (ammonium adj hydroxide) or (nh adj2 oh) or (tetra adj2 methyl adj ammonium and hydroxide) or tmah)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2003/12/04 02:20 |
| S20 | 5 | ((((((((damascene and copper) and barrier and seed) and adhesion) and ((expos\$4 same barrier) or ((etch\$4 or remove) same seed))) and (electrolyte or electrolyt\$3)) and potential) and (electrolyt\$5 same (koh or (potassium adj hydroxide) or naoh or (sodium adj hydroxide) or (ammonium adj hydroxide) or (nh adj2 oh) or (tetra adj2 methyl adj ammonium and hydroxide) or tmah))) and ph | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2003/12/04 02:22 |

| S21 | 5 | ((((((((((((((((((((((((((((((((((((((| US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2003/12/04 02:22 |
|-----|---|--|---|----|-----|------------------|
| S22 | 2 | hydroxide) or tmah))) and ph) (("20020074238") or ("20030207558")).PN. | US-PGPUB; USPAT; USOCR | OR | OFF | 2004/06/04 13:57 |